## SPACE – COMPONENTS

**SOLUTIONS** 

**CHALLENGES** 

Chemical Analysis /Spectroscopy	<ul> <li>Detection and quantification of impurities</li> <li>Optical transmission/reflection</li> <li>Surface height/roughness; accuracy of manufacturing steps</li> </ul>	<ul> <li>✓ Fourier Transform Infrared Analysis</li> <li>✓ Ultraviolet Visible Spectroscopy</li> <li>✓ Atomic force Microscope</li> </ul>
Device / Internal Analysis	<ul> <li>Visible inspection of defects/failures</li> <li>Removal of organic compounds/surface cleaning</li> <li>Measurements of surface resistivity</li> <li>Long duration testing at AMO</li> <li>Cross sectional analysis/imaging of small scale defects (&lt;100nm)</li> <li>Depth profiling, identifying contaminants/impurities</li> <li>Surface cleaning, surface mapping of elements</li> </ul>	<ul> <li>✓ High Magnification Optical Microscopes</li> <li>✓ Plasma Etcher</li> <li>✓ Probe Stations for Device Characterisation</li> <li>✓ Class 'A' solar simulator and light soakers</li> <li>✓ Focussed Ion Beam/SEM</li> <li>✓ TOF-SIMS</li> </ul>
Electrical/ Electronic Test	<ul><li>Resistivity measurements</li><li>Permittivity calculations</li></ul>	<ul> <li>✓ Agilent Femto-Amp resolution parameter analysers</li> <li>✓ Automated Test Equipment</li> </ul>
Environmental Testing	<ul> <li>Space qualification first article testing</li> <li>Accelerated weathering / UV degradation</li> </ul>	<ul> <li>✓ Outdoor test rigs for solar modules</li> <li>✓ Weather station and irradiance sensor</li> <li>✓ Environmental Chambers</li> </ul>
Electron Microscopy/ Surface Analysis	<ul> <li>External visual inspection for cracks/failures/defects</li> <li>Elemental analysis</li> <li>Surface roughness of optical coatings</li> <li>Definition of bulk crystal structure</li> <li>Optical constants, non-destructive change to optical properties</li> <li>Film thickness calculations</li> </ul>	<ul> <li>✓ Field Emission Scanning Electron Microscopy</li> <li>✓ Energy Dispersive X-ray Spectroscopy</li> <li>✓ Atomic Force Microscopy</li> <li>✓ X-ray Diffraction</li> <li>✓ Ellipsometry</li> <li>✓ Focussed Ion Beam(via partner)</li> </ul>
Materials Processing	<ul> <li>Thin-film coatings</li> <li>Electrical contact/dielectric/AR coating</li> <li>Electrical contact/dielectric/AR coating</li> </ul>	<ul> <li>✓ Electron Beam deposition</li> <li>✓ Thermal evaporation of metals, organic materials</li> <li>✓ Class 1000 cleanroom</li> </ul>
Non-Destructive Analysis	<ul> <li>Surface roughness of optical coatings</li> <li>Definition of bulk crystal structure</li> </ul>	<ul> <li>✓ Probe station, surface analysis equipment - AFM</li> <li>✓ Probe station, surface analysis equipment - XRD</li> </ul>
Electrostatic Testing	<ul> <li>Surface resistivity measurement</li> <li>Charge Decay monitoring</li> <li>Field Meter measurement</li> <li>Conduction to ground monitoring</li> <li>Powder coating test set</li> </ul>	<ul> <li>✓ Surface resistivity measurement</li> <li>✓ Charge Decay monitoring</li> <li>✓ Field Meter measurement</li> <li>✓ Conduction to ground monitoring</li> <li>✓ Powder coating test set</li> </ul>
Software	<ul> <li>High Performance Computing access</li> </ul>	✓ High Performance Computing access